

SCOPE: PIN-PROGRAMMABLE PRECISION VOLT REFERENCE

| Device Type | Generic Number |
|--------------------|-----------------------|
| 01 | MX584S(x)/883B |
| 02 | MX584T(x)/883B |

Case Outline(s). The case outlines shall be designated in Mil-Std-1835 and as follows:

| Outline Letter | Mil-Std-1835 | Case Outline | Package Code |
|-----------------------|----------------------|---------------------|---------------------|
| MAXIM SMD | | | |
| H G | MACY1-X3 | 8 Lead TO-99 Can | G99 |
| Q P | GDIP1-T8 or CDIP2-T8 | 8 Lead CERDIP | J8 |

Absolute Maximum Ratings

Input Voltage to GND 40V

Lead Temperature (soldering, 10 seconds) +300°C
Storage Temperature -65°C to +150°C

Continuous Power Dissipation $T_A = +70^\circ\text{C}$
8-Pin TO-99 Can(derate 6.1mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 533mW
8-Pin CERDIP(derate 8.0mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 640mW
Junction Temperature T_J +150°C

Thermal Resistance, Junction to Case, Θ_{JC} :

8-Pin TO-99 Can 45°C/W
8-Pin CERDIP 55°C/W

Thermal Resistance, Junction to Ambient, Θ_{JA} :

8-Pin TO-99 Can 150°C/W
8-Pin CERDIP 125°C/W

Recommended Operating Conditions

Supply Voltage Range (V_{IN}) 4.5V min to 30V max
Ambient Operating Range (T_A) -55°C to +125°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TABLE 1 ELECTRICAL TESTS

| TEST | Symbol | CONDITIONS -55 °C ≤ T _A ≤ +125°C V _{CC} =+15V, 10V output, I _L =0mA Unless otherwise specified | Group A Subgroup | Device type | Limits Min <u>1/</u> | Limits Max <u>1/</u> | Units |
|--|-------------------------------|--|---------------------|----------------|----------------------------|----------------------------|--------|
| Quiescent Current | I _Q | V _{IN} =38V, V _O =10V | 1 | All | 0 | 1.0 | mA |
| Output Voltage Error | V _{OUT1} | 10V Output | 1 | 01 02 | 9.97 9.99 | 10.03 10.01 | mV |
| | V _{OUT2} | 7.5V Output | 1 | 01 02 | 7.478 7.492 | 7.522 7.508 | |
| | V _{OUT3} | 5.0V Output | 1 | 01 02 | 4.985 4.994 | 5.015 5.006 | |
| | V _{OUT4} | 2.5V Output | 1 | 01 02 | 2.4925 2.4965 | 2.5075 2.5035 | |
| Line Regulation | VR _{LINE1} | 12.5V ≤ V _{IN} ≤ 15V, V _O =10V | 1 2,3 | All | | ±.005 ±.010 | %/V |
| NOTE 1 | VR _{LINE2} | 15V ≤ V _{IN} ≤ 30V, V _O =10V | 1 2,3 | | | ±.002 ±.005 | |
| Load Regulation | VR _{LOAD} 1,2,3,4 | I _L =0mA to 5mA, Output=10V, 7.5V, 5V, 2.5V | 1 2,3 | All | | ±50 ±100 | ppm/mA |
| Output Short Circuit Current | I _{OS} | V _O =10V | 1,2,3 | All | | -55 | mA |
| Output Voltage Temperature Coefficient | ΔV _{OUT1} / ΔT | 10V Output | 2,3 | 01 02 | | ±0.3 ±0.15 | %FS |
| | ΔV _{OUT2} / ΔT | 7.5V Output | 2,3 | 01 02 | | ±0.3 ±0.15 | |
| | ΔV _{OUT3} / ΔT | 5.0V Output | 2,3 | 01 02 | | ±0.3 ±0.15 | |
| | ΔV _{OUT4} / ΔT | 2.5V Output | 2,3 | 01 02 | | ±0.3 ±0.2 | |
| Output Noise | N _O | V _O =10V, 0.1Hz ≤ BW ≤ 10Hz | 4 | All | | 50 | μVp-p |
| | | V _O =10V, 10Hz ≤ BW ≤ 100Hz=kHz | | | | 150 | μV rms |
| Settling Time 0.1% of final value (power up) | t _{S(p)} | V _O =10V, I _L =0mA NOTE 2 | 9 | All | | 1000 | μs |
| | | V _O =10V, I _L =5mA NOTE 2 | | | | 1000 | |

NOTE 1: The limiting terms "min" (minimum) and "max" (maximum) shall be considered to apply to magnitudes only. Negative current is defined as conventional current flow out of a device.

NOTE 2: Guaranteed, if not tested, to the limits specified in Table 1.

ORDERING INFORMATION:

| Device | Maxim Part Number | SMD Number |
|--------|-------------------|-----------------|
| 01 | MX584SH/883B | 5962-3812803MGC |
| 01 | MX584SQ/883B | 5962-3812803MPA |
| 02 | MX584TH/883B | 5962-3812804MGC |
| 02 | MX584TQ/883B | 5962-3812804MPA |

PIN CONFIGURATIONS:

| PIN | J8/G99 |
|-----|-----------------|
| 1 | 10.0V |
| 2 | 5.0V |
| 3 | 2.5V |
| 4 | GND |
| 5 | STROBE |
| 6 | V _{BG} |
| 7 | CAP |
| 8 | V _{CC} |

QUALITY ASSURANCE

Sampling and inspection procedures shall be in accordance with MIL-Prf-38535, Appendix A as specified in Mil-Std-883.

Screening shall be in accordance with Method 5004 of Mil-Std-883. Burn-in test Method 1015:

1. Test Condition, A, B, C, or D.
2. TA = +125°C minimum.
3. Interim and final electrical test requirements shall be specified in Table 2.

Quality conformance inspection shall be in accordance with Method 5005 of Mil-Std-883, including Groups A, B, C, and D inspection.

Group A inspection:

1. Tests as specified in Table 2.
2. Selected subgroups in Table 1, Method 5005 of Mil-Std-883 shall be omitted.

Group C and D inspections:

- a. End-point electrical parameters shall be specified in Table 1.
- b. Steady-state life test, Method 1005 of Mil-Std-883:
 1. Test condition A, B, C, D.
 2. TA = +125°C, minimum.
 3. Test duration, 1000 hours, except as permitted by Method 1005 of Mil-Std-883.

TABLE 2. ELECTRICAL TEST REQUIREMENTS

| Mil-Std-883 Test Requirements | Subgroups per Method 5005, Table 1 |
|--|------------------------------------|
| Interim Electric Parameters Method 5004 | 1 |
| Final Electrical Parameters Method 5005 | 1*, 2, 3, 4, 9 |
| Group A Test Requirements Method 5005 | 1, 2, 3, 4, 9 |
| Group C and D End-Point Electrical Parameters Method 5005 | 1 |

* PDA applies to Subgroup 1 only.